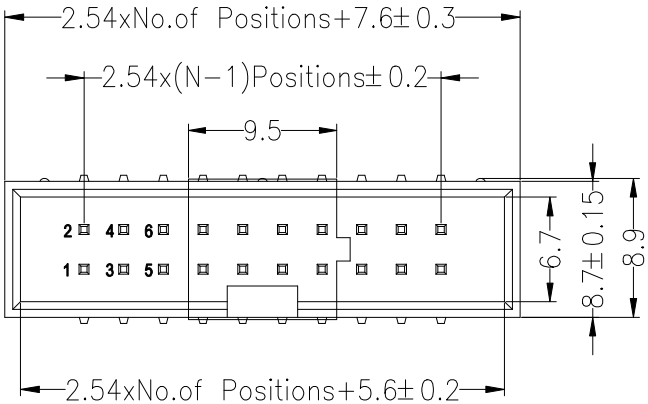
HSF RoHS

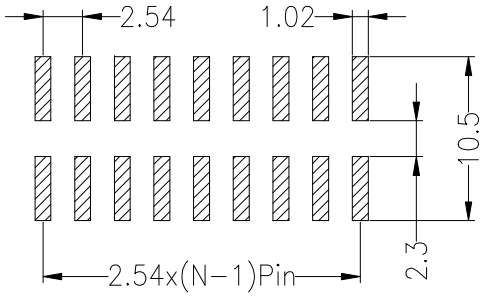
FILE NO :E362810

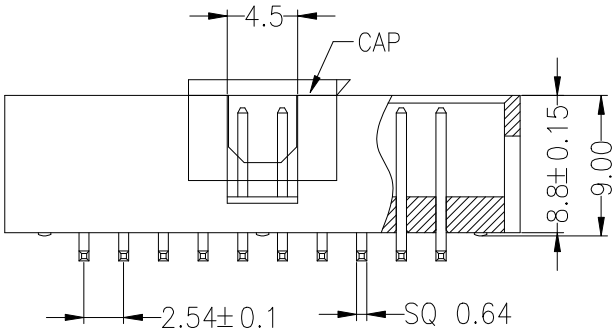
SPECIFICATIONS
Rated Current:3.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:1000V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

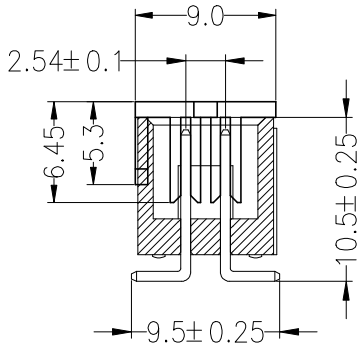
Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PA6T
Max.Processing Temp: 230°C for 30−60 seconds
(260°C for 10 seconds)




Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE± 0.05)




## *Ordering Information*

**3210 XX M XX X B K00 X 0X**

| | | | | | |
|---|---|---|---|---|---|
| No.of Pins 06−64P | Contact Plating G0:Gold Flash G1:1U" Gold G2:1.5U" Gold G3:2U" Gold G4:3U" Gold G5:5U" Gold G6:10U" Gold G7:15U" Gold S0:Gold Flash/Tin SN:Tin | Insulator Material Option C=PA6T E=PA9T F=LCP | Packing 0=PE Bag A=Tray T=Tube P=Tube+Cap R=Reel+Cap | Stream code 01~99 | |

| REV | DATE | MODIFICATION DESCRIPTION | CHANGE |
|---|---|---|---|
| A0 | 2021.08.17 | NEW DRAWING | |

| OPERATION | |
|---|---|
| X.X | ± 0.30 |
| X.XX | ± 0.20 |
| X.XXX | ± 0.10 |
| Angle | ± 3° |
| DIM | TOL |

| | | |
|---|---|---|
| DRAW | Liu Miao | 21.08.17 |
| CHECK | | |
| APPROVE | | |

| | |
|---|---|
| SCALE | FIT |
| UNIT | mm |
| SIZE | A4 |
| SHEET | 1/1 |
| PROJ. | |

WFD CONN 深圳市旺富达电子有限公司
SHEN ZHEN WFD ELECTRONICS CO., LTD

| | |
|---|---|
| PART NO. | 3210XXMXXXBK00X0X |
| TITLE: | 2.54mm Box Header H8.8mm SMT |